



High Performance Wafer Handling Tools Since 1975

MCP2-23-S

50mm -76mm Wafer Handling Edge-Grip Mechanical Pick

Ordering part number: MCP2-23-S

Wafer Size – 50mm x 350 μ or 76mm x 350 μ

An edge-grip normally closed (consistent force) edge exclusion mechanical pick for handling 2"-3" (50mm-76mm) round substrates from the wafer edge. This special version features a leading knife tongue for lifting a wafers off of a flat surface. Base material is ESD safe polypropylene for longevity, antistatic properties, and general chemical resistance. Wafer contact pad is perfluorinated o-ring strip for grip/hold on the wafer without scratching or leaving outgassing behind.

Handle length: 7.0" (177.8mm), Gripper width: 1.40" (35.5mm)

50mm Frontside contact: 3mm, Backside contact: 10mm

76mm Frontside contact: 2mm, Backside contact: 10mm

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2" (50mm)-3" (76mm) Edge Mechanical Pick

